

RADIO-FREQUENCY SWITCHING DEVICE, IN PARTICULAR FOR  
MOBILE CELLULAR TELEPHONES

Field of the Invention

The present invention relates to radio-frequency switching devices, and in particular, to those incorporated in wireless communication system terminals, such as mobile cellular telephones operating under different transmission standards (GSM, DCS, PCS, WCDMA, etc.).

Background of the Invention

When a terminal such as a mobile cellular telephone is designed to operate with different transmission standards, an antenna switching device is required. The antenna switching device selectively switches the reception and/or transmission channels dedicated to each standard to an antenna.

Traditional radio-frequency switching devices are based on PIN diodes, a line biplexer and quarter wave transmission lines, as readily understood by those skilled in the art. A PIN diode is formed by a P<sup>+</sup> region, an N<sup>+</sup> region and a region of intrinsic semiconductor material between the P<sup>+</sup> and N<sup>+</sup> regions.

Such devices have size disadvantages, in particular, due to the high number of very high quality inductors (seven for a five pole switching device) and capacitors. This also significantly increases the cost

of the finished product.

Summary of the Invention

In view of the foregoing background, an  
5 object of the present invention is to provide a  
relatively straightforward and inexpensive radio-  
frequency switching device that is also compact.

Another object of the present invention is to  
provide a radio-frequency switching device having very  
10 good radio-frequency isolation when one of the radio-  
frequency channels is selected in order to reduce the  
loss of energy in the selected channel.

These and other objects, advantages and  
features in accordance with the present invention are  
15 provided by a radio-frequency switching device  
comprising at least a first radio-frequency channel and  
a second radio-frequency channel connected together at  
an input/output terminal. The radio-frequency  
switching device may further comprise an antenna, and  
20 controllable switching means for selecting one of the  
radio-frequency channels in response to a switching  
control signal.

According to one general characteristic of  
the invention, the switching means may comprise a  
25 control module for each radio-frequency channel. Each  
control module may comprise a PIN diode whose cathode  
is connected to the input/output terminal, and a  
control transistor whose base is connected to an input  
control that receives the switching control signal.  
30 Furthermore, the sink (collector) of this control  
transistor may be connected to the anode of the PIN  
diode for forming the common node between the PIN anode  
intersections. According to a preferred embodiment,

the control transistor comprises a lateral PNP transistor.

The radio-frequency switching device may have more than two radio-frequency channels connected 5 together at the input/output terminal. For example, it may comprise five radio-frequency channels, thus forming a device with five poles that is much more compact and less expensive than a five pole device of the prior art.

10 The radio-frequency switching device may advantageously be in the form of an integrated circuit. In one application of wireless communications, the input/output terminal may have a radio-frequency antenna, and the radio-frequency channels may have 15 dedicated transmission channels and dedicated reception channels.

To adapt to multi-standard transmissions, the radio-frequency switching device advantageously includes channels respectively dedicated to different 20 transmission standards operating at different frequencies. These channels include those dedicated to GSM reception and transmission, DCS/PCS reception and transmission, and WCDMA reception and transmission, for example.

25 Another aspect of the present invention is directed to a terminal that is remote from the wireless communication system, such as a mobile cellular telephone comprising a radio-frequency switching device as described above.

30 **Brief Description of the Drawings**

Other advantages and characteristics of the invention will become clear upon reading the detailed

description of the embodiments, which are in no way restrictive, and the appended drawings, in which:

Figure 1 is a diagrammatic representation of an embodiment of a radio-frequency switching device 5 according to the present invention;

Figure 2 is a diagrammatic representation of a transistor for controlling a device according to the present invention;

Figure 3 is a diagrammatic representation of 10 the equivalent circuit of the transistor illustrated in Figure 2;

Figure 4 is a more detailed diagrammatic representation of a device control module according to the present invention; and

15 Figure 5 is another diagrammatic and partial representation of a device control module according to the present invention.

#### Detailed Description of the Preferred Embodiments

In Figure 1, the DCM reference designates a 20 radio-frequency switching device integrated, for example, in a mobile cellular telephone capable of operating to the GSM, DCS or PCS standards. This switching device DCM comprises an antenna ANT as well as five radio-frequency channels, respectively 25 referenced as follows: TXGSM for the transmission channel using the GSM standard; RXGSM for the reception channel using the GSM standard; TXDCS/PCS for the transmission channel using the DCS or PCS standard; RXDCS for the reception channel using the DCS standard; 30 and RXPCS for the reception channel using the PCS standard.

Figure 1 diagrammatically shows these radio-

frequency channels by a double circle, such as the RXGSM channel, for example. Each of these channels includes a frequency transposition device, a low interference amplifier with controlled gain levels, as 5 well as an analog/digital and digital/analog converter linked to the telephone's digital processor. In particular, the processor carries out the basic frequency band processing, such as channel decoding, channel encoding, source decoding and source encoding.

10 The switching device DCM further comprises switching means that can be controlled by the mobile telephone's processor, so that one of these radio-frequency channels may be selected in response to a switching control signal. The controllable switching 15 means comprises a control module for each radio-frequency channel. More precisely, each control module, such as the module connected to the RXGSM radio-frequency module, comprises a PIN diode referenced DPN1, whose cathode is connected to the 20 antenna ANT. The anode of this PIN diode is connected to the radio-frequency channel RXGSM via a capacitor.

A PIN diode is formed by a  $P^+$  region, and an  $N^+$  region surrounding an intrinsic semi-conductor material, as readily understood by those skilled in the 25 art. When such a diode is directly biased, charge carriers appear in the intrinsic region which then becomes conductive. However, when the diode is reversed biased, these charge carriers disappear from the intrinsic region which remains resistive. At low 30 frequencies, a PIN diode operates like a variable resistor that depends on the biasing current. The threshold frequency of the PIN diode is chosen so that it is much lower than the frequencies used in the

various transmission standards.

Apart from this diode DPN1, the control module that is on the RXGSM channel comprises a control transistor Q1, which in this case is a PNP type lateral transistor. The transistor Q1 sink (collector) is connected to the anode of the diode DPN1 via a shock inductor L1, whose function is to allow the DC current to pass and to resist the high frequency current. The transistor Q1 sink is furthermore connected to ground via another capacitor.

The transistor Q1 emitter is connected to the supply voltage Vdd and its base is connected to an input control EC1 that receives the logic switching control signal. Two biasing resistors RP10 and RP11 provide the biasing current for the transistor Q1.

The other control modules, respectively connected to the other radio-frequency channels, are identical to that which has just been described. Apart from the switching modules, the CM module also comprises an NPN transistor referenced Q6 whose sink is connected to the antenna and whose transmitter (emitter) is connected to ground. The base of this transistor Q6 is connected to another control input EC6 that receives a transmission/reception switching signal. The transistor Q6 operates as a current source to limit the current to about 300 mA in the reception mode, and at about 4 mA in the transmission mode, for example.

The transmission/reception switching signal is consequently a signal capable of taking two values, in order to give the transmission mode a higher current than the reception mode. The current values given above are such that in the reception mode the power

consumption of the receiver is not penalized while also maintaining a resistance of the PIN diodes sufficiently low for low amplitude RF signals.

For example, when the TXGSM radio-frequency  
5 channel is to be selected, which is to say the transmission channel dedicated to the GSM standard, the telephone processor applies a switching control signal having a logic value of 0 to the EC4 control input and a logic value 1 to the EC1, EC2, EC3 and EC5 control  
10 inputs. Consequently, the transistor Q4 allows the current to pass and the DC current conducts from the Vdd supply to ground via the transistor Q4, the inductor L4, the diode DP4 and the transistor Q6.

The diode DP4 is in a state of low  
15 resistance, whereas all of the other PIN diodes are in a high resistance state, thus isolating the other radio-frequency channels. Furthermore, in this configuration, the switching signal supplied to the input EC6 is in its low logic state in order to allow  
20 the conduction of a high current, for example, 4 mA.

It is especially important to obtain good isolation of the other channels that are not selected. Thus, when a transmission mode is selected, for example, all of the other channels are in parallel in  
25 their high isolation mode. Any deterioration to this isolation will have a direct affect on the loss of energy from the channel selected.

Thus, by way of example, when the GSM channel is selected, the peak/peak voltage at the antenna  
30 connector is +/- 15 Volts for a GSM power of around 36 dBm. Since the cathodes of the PIN diodes of the channels not selected can see this signal, current leaks can arise through these PIN diodes. In this

example the diodes DPN1, DPN2, DPN3 and DPN5 in the corresponding control transistors have an equivalent diode biased in the same direction. This would be the case for NPN type transistors, or possibly for PNP type 5 control transistors with electrostatic discharge protection diodes (ESD protection) as part of the integrated circuit.

In this case, the isolation could be very low with a loss of around 6 dB in the transmission channel 10 selected, which is not acceptable. An approach to this problem could then be to apply a negative voltage equal to the peak voltage (-15 Volts) to the anode of each of the PIN diodes not selected in order to reverse bias these diodes. However, such an approach is not possible 15 in a mobile telephone, in which the supply voltage Vdd is low, which is typically equal to 2.7 Volts.

The invention addresses this problem by combining with the PIN diode a control transistor whose sink is connected to the anode of this PIN diode. The 20 sink is seen as forming the common node between the two PIN intersection anodes. One approach for creating such a transistor is to use a PNP lateral transistor as shown in Figure 2.

This transistor is, in this case, in an N 25 doped casing CS separated from the P doped substrate SB by an N<sup>+</sup> doped buried layer CE. This layer CE is in contact with the base via an N<sup>+</sup> well. The casing CS forming the active zone of the transistor is isolated from the rest of the substrate SB by lateral isolation 30 casings CIS. P<sup>+</sup> wells allow the substrate to be biased.

The sink (collector) and transmitter (emitter) regions, the P<sup>+</sup> doped regions, and the corresponding contacts are also housed inside the CS

casing. Electrically, the equivalent diagram of this lateral transistor Q1 is illustrated in Figure 3. In this figure, the transistor Q1 designates the lateral transistor, whereas the transistors Q20 and Q30 5 represent PNP type parasitic transistors.

It can therefore be seen, by referring more particularly to Figure 4, that, in this case, the transistor Q1 sink is seen as forming the common node between the anode of the intersection of PN (diode) J1 10 formed by the sink/base of transistor Q1, and PN (diode) J30 of the parasitic transistor Q30. These various intersections are also shown in Figure 5.

Consequently, since the anode of the PIN diode, referenced DPN1, and the anodes of the 15 equivalent diodes of the Qi transistor, which is the anodes of diodes J1 and J30, are connected together, there is no current likely to pass through the diode DPN. This is regardless of the voltage applied to the cathode of the DPN1 diode when the control transistor 20 Q1 is blocked.

The diode DPN1 therefore remains in its reversed biased state, maintaining a high resistive value. The isolation is not affected, even at high power. Consequently, the energy losses in the active 25 channel selected remain below 0.5 dB, which is very acceptable. Of course, the rationale that has been applied here for the diode DPN1 and the transistor Q1 applies to the PIN diodes of the channels not selected, and for the corresponding control transistors.

30 The combination of PIN diodes with their cathodes connected together, and controlled in series by PNP lateral transistors, avoids the use of a biplexer and quarter wave transmission lines. This

results in a substantial savings in passive components such as a five pole radio-frequency switching device as illustrated in Figure 1, and results in seven high quality inductors and fifteen capacitors not being 5 used. Furthermore, the device avoids the use of a high negative supply voltage to maintain a good level of performance. The use of PIN diodes with common cathodes means that they can be incorporated onto the same integrated circuit board, this reducing its size.